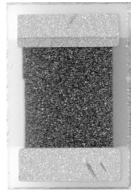


## Thin Film 0304 Size Resistor on Alumina



Product may not be to scale

The CC6 series single-value resistor chips offer a small size, low shunt capacitance and solder pad option.

The CC6s nichrome resistor material offers excellent stability. The CC6s are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The CC6s are 100% electrically tested and visually inspected to MIL-STD-883.

### APPLICATIONS

Vishay EFI CC6 chip resistors provide excellent high-frequency response and are ideally suited for prototyping. Typical application areas are:

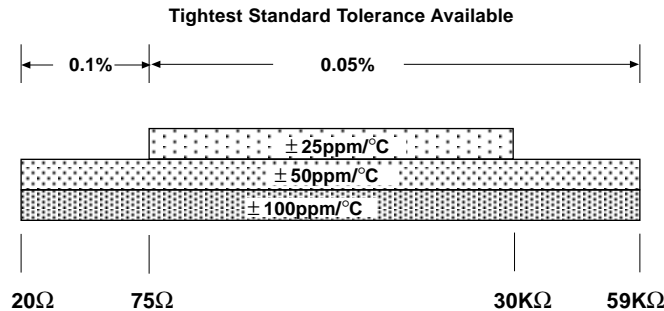
- Amplifiers
- Oscillators
- Attenuators
- Couplers
- Filters

Recommended for hermetic applications where die is not exposed to moisture.

### FEATURES

- Chip size: 0.030 x 0.045 inches
- Resistance range: 20Ω to 59kΩ
- Alumina substrate
- Low stray capacitance: < 0.2pF
- Resistor material: nichrome
- Resistor passivation coat optional
- Tolerances to 0.05%
- Solder pad optional

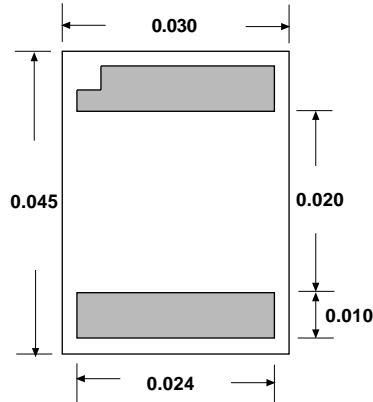
### TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES AND TOLERANCES



### STANDARD ELECTRICAL SPECIFICATIONS

PARAMETER	
Noise, MIL-STD-202, Method 308	- 20dB typical
Moisture resistance, MIL-STD-202 Method 106 - Hermetic applications	± 0.2% maximum ΔR/R
Stability, 1000 hours, + 125°C, 65mW	± 0.1% maximum ΔR/R
Operating temperature range	- 55°C to + 125°C
Thermal shock, MIL-STD-202, Method 107, Test condition F	± 0.25% maximum ΔR/R
High temperature exposure, + 150°C, 100 hours	± 0.1% maximum ΔR/R
Dielectric voltage breakdown	400V
Insulation resistance	10 <sup>12</sup> minimum
Operating voltage	100V maximum
DC power rating at + 125°C (derated to zero at + 150°C)	65mW maximum
5 x rated power short-time overload, + 25°C, 5 seconds	± 0.25% maximum ΔR/R

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**DIMENSIONS** in inches

**SCHEMATIC**


<b>MECHANICAL SPECIFICATIONS</b> in inches	
PARAMETER	
Chip size	0.030 x 0.045 ± 0.003 (0.762 x 1.143 ± 0.076mm)
Chip thickness	0.010 ± 0.002 (0.25 ± 0.05mm)
Chip substrate material	99.6% alumina, 2-4 microinch finish
Resistor material	Nichrome
Bonding pad size	0.010 x 0.024 (0.254 x 0.61mm) minimum
Number of pads	2
Pad material	25kÅ minimum gold standard
Backing	None

**OPTIONS:** Terminations: Aluminum, Nickel solder (62/32)  
 Gold back for solder die attach  
 Contact Applications Engineer

<b>ORDERING INFORMATION</b>						
Example: 100% visualled, 50Ω, ± 10%, ± 50ppm/°C TCR, Gold Terminations, Resistor coated (thermal set plastic), Class H						
W INSPECTION /PACKAGING	CC6 PRODUCT FAMILY	5000 RESISTANCE VALUE	B MULTIPLIER CODE	K TOLERANCE CODE	D TCR	GC TERMINATIONS
W = 100% visually inspected parts in matrix tray per MIL-STD-883 X = Sample, commercial visually inspected loaded in matrix trays (4% AQL)		Use first 4 or 5 significant digits of resistance	B = 0.01 A = 0.1 0 = 1 1 = 10 2 = 100	A = 0.05%* B = 0.1%* C = 0.25%* D = 0.5% F = 1.0% G = 2.0% J = 5.0% K = 10%	A = ± 10ppm/°C B = ± 25ppm/°C D = ± 50ppm/°C E = ± 100ppm/°C	G = Gold S = Solder GC = Gold/Coated SC = Solder/Coated
					*Coating standard	